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# N-Channel Power Trench<sup>®</sup> MOSFET 25 V, 7.5 m $\Omega$

#### Features

- Max  $r_{DS(on)}$  = 7.5 m $\Omega$  at V<sub>GS</sub> = 10 V, I<sub>D</sub> = 15 A
- Max  $r_{DS(on)}$  = 11.1 m $\Omega$  at V<sub>GS</sub> = 4.5 V, I<sub>D</sub> = 12 A
- Advanced Package and Silicon combination for low r<sub>DS(on)</sub> and high efficiency
- Next generation enhanced body diode technology, engineered for soft recovery
- MSL1 robust package design
- 100% UIL tested
- RoHS Compliant

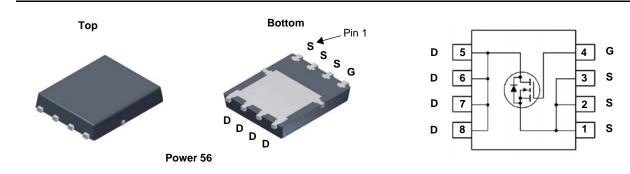


#### **General Description**

This N-Channel MOSFET has been designed specifically to improve the overall efficiency and to minimize switch node ringing of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low  $r_{DS(on)}$ , fast switching speed and body diode reverse recovery performance.

#### Applications

- Control MOSFET for Synchronous Buck Converters
- Notebook
- Server
- Telecomm
- High Efficiency DC-DC Switch Mode Power Supplies



#### MOSFET Maximum Ratings T<sub>A</sub> = 25 °C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V <sub>DS</sub>	Drain to Source Voltage			25	V	
V <sub>GS</sub>	Gate to Source Voltage		(Note 4)	±20	V	
ID	Drain Current -Continuous (Package limited)	T <sub>C</sub> = 25 °C		28		
	-Continuous (Silicon limited)	T <sub>C</sub> = 25 °C		49		
	-Continuous	T <sub>A</sub> = 25 °C	(Note 1a)	15	Α	
	-Pulsed			60		
E <sub>AS</sub>	Single Pulse Avalanche Energy		(Note 3)	32	mJ	
P <sub>D</sub>	Power Dissipation	T <sub>C</sub> = 25 °C		27		
	Power Dissipation	T <sub>A</sub> = 25 °C	(Note 1a)	2.5		
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range			-55 to +150	°C	

#### **Thermal Characteristics**

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	4.6	°C/W
$R_{ hetaJA}$	Thermal Resistance, Junction to Ambient (Note	1a) 50	C/W

#### Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity	
FDMS7580	FDMS7580	Power 56	13 "	12 mm	3000 units	

FDMS7580
N-Channel F
ower Trench
<sup>®</sup> MOSFET

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units	
Off Chara	cteristics						
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	I <sub>D</sub> = 250 μA, V <sub>GS</sub> = 0 V				V	
ΔBV <sub>DSS</sub> ΔT <sub>J</sub>	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		18		mV/°C	
IDSS	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 20 V, V <sub>GS</sub> = 0 V			1	μA	
I <sub>GSS</sub>	Gate to Source Leakage Current	$V_{GS} = 20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$			100	nA	
On Chara	cteristics						
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \ \mu A$	1.0	1.6	3.0	V	
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		-6		mV/°C	
r <sub>DS(on)</sub>		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 15 A		5.9	7.5		
	Static Drain to Source On Resistance	V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 12 A		8.3	11.1	mΩ	
		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 15 A, T <sub>J</sub> = 125 °C		8.3	10.6	7	
9 <sub>FS</sub>	Forward Transconductance	V <sub>DD</sub> = 5 V, I <sub>D</sub> = 15 A		63		S	
C <sub>iss</sub> C <sub>oss</sub>	Input Capacitance Output Capacitance Reverse Transfer Capacitance	$V_{DS} = 13 \text{ V}, V_{GS} = 0 \text{ V},$ f = 1 MHz		894 277 53	1190 370 80	pF pF	
C <sub>rss</sub>	-			53 1.1	80 2.2	pF	
R <sub>g</sub>	Gate Resistance			1.1	2.2	Ω	
Switching	g Characteristics						
t <sub>d(on)</sub>	Turn-On Delay Time			7.3	15	ns	
t <sub>r</sub>	Rise Time	V <sub>DD</sub> = 13 V, I <sub>D</sub> = 15 A,		2.4	10	ns	
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		17	31	ns	
t <sub>f</sub>	Fall Time			2.1	10	ns	
Q <sub>g(TOT)</sub>	Total Gate Charge	$V_{GS} = 0 V \text{ to } 10 V$		14	20	nC	
	Total Gate Charge	$V_{GS} = 0 V \text{ to } 4.5 V V_{DD} = 13 V$		6.5	10	nC	
Q <sub>gs</sub>	Total Gate Charge	I <sub>D</sub> = 15 A		2.9		nC	
Q <sub>gd</sub>	Gate to Drain "Miller" Charge			1.6		nC	
Drain-Sou	arce Diode Characteristics						
V <sub>SD</sub>		$V_{GS} = 0 V, I_S = 2 A$ (Note 2)		0.73	1.1	V	
▼ SD	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 15 A$ (Note 2)		0.85	1.2	v	
t <sub>rr</sub>	Reverse Recovery Time	I <sub>F</sub> = 15 A, di/dt = 100 A/μs		19	34	ns	
Q <sub>rr</sub>	Reverse Recovery Charge	$r_{\rm F} = 10$ Å, u/u = 100 Å/µs		5.1	10	nC	
-							

Q<sub>rr</sub> NOTES:

t<sub>rr</sub>

1. R<sub>0,JA</sub> is determined with the device mounted on a 1 in<sup>2</sup> pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R<sub>0,JC</sub> is guaranteed by design while R<sub>0CA</sub> is determined by the user's board design.

 $I_F = 15 \text{ A}, \text{ di/dt} = 300 \text{ A/}\mu\text{s}$ 



Reverse Recovery Time

Reverse Recovery Charge

a. 50 °C/W when mounted on a 1 in<sup>2</sup> pad of 2 oz copper

b.125 °C/W when mounted on a minimum pad of 2 oz copper

15

8.9

27

18

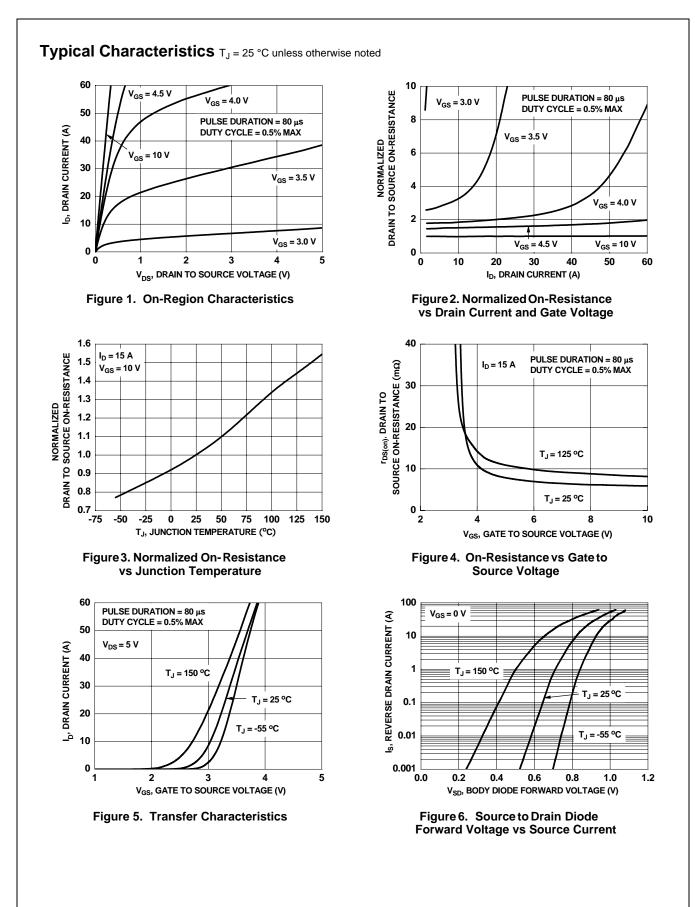
ns



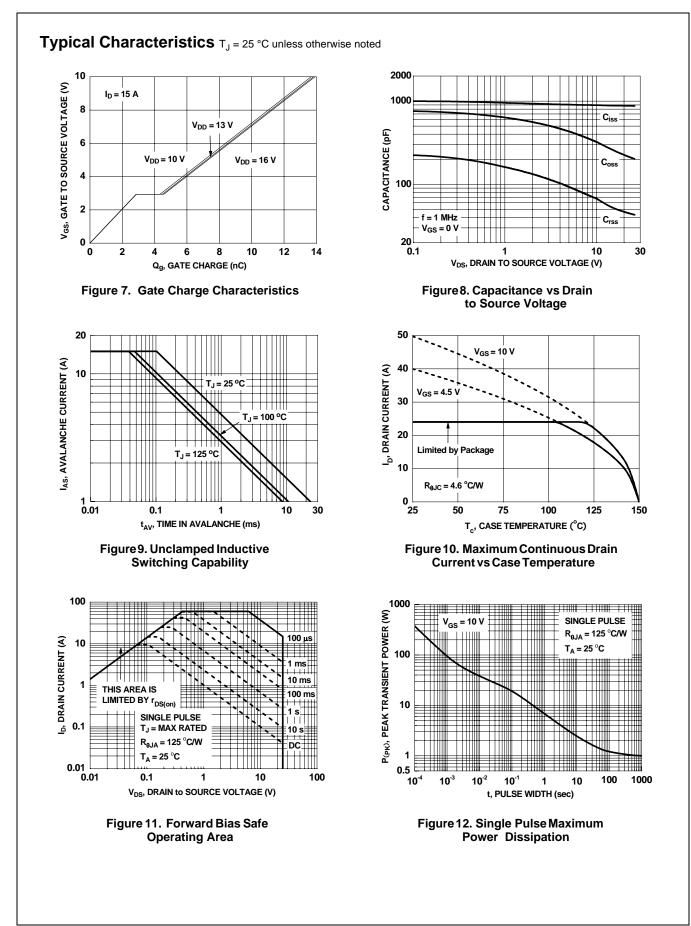
2. Pulse Test: Pulse Width < 300  $\mu s,$  Duty cycle < 2.0 %.

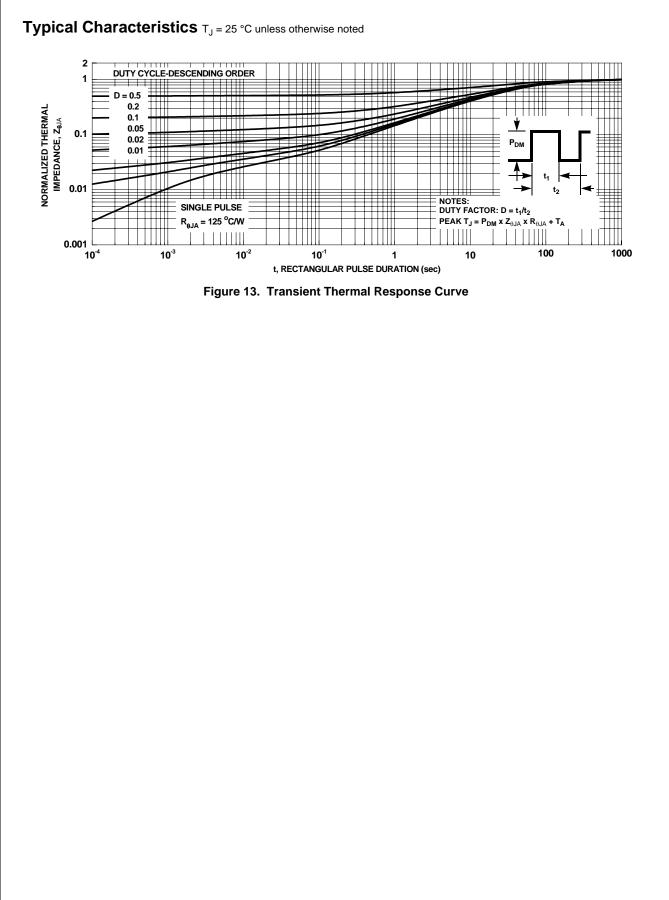
3.  $E_{AS}$  of 32 mJ is based on starting  $T_J$  = 25 °C, L = 1 mH,  $I_{AS}$  = 8 A,  $V_{DD}$  = 23 V,  $V_{GS}$  = 10 V. 100% test at L = 0.3 mH,  $I_{AS}$  = 12 A.

4. As an N-ch device, the negative Vgs rating is for low duty cycle pulse occurrence only. No continuous rating is implied.









FDMS7580 N-Channel Power Trench<sup>®</sup> MOSFET



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